

## Chip Removal Alloy (1 foot, 3.175mm THICK Diameter) for SMD/SMT (2-6.5" sticks)

### Product Highlights


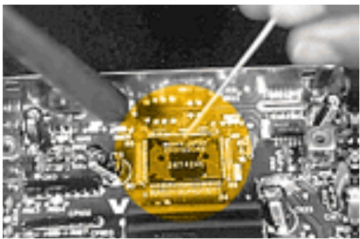


Easily remove SMD parts with **Chip Quik®** removal alloy  
Reduce heat and reduce damage to circuit boards and SMD parts during removal  
Comes with SMDLT flux

### Specifications

Alloy:	<b>Chip Quik®</b> Alloy Leaded 2-6.5in. Thick Sticks
Alloy Melting Point:	58°C (136°F)
Thickness:	3.175mm (0.125")
Flux:	SMDLT 2cc/2g Squeeze Tube
Flux Type:	No-Clean
Flux Classification:	RELO
Flux Activation Temperature:	100°C (212°F)



### Chip Quik® Instructions

	1	Apply Chip Quik flux to all leads of SMD with syringe or flux applicator.
	2	Melt Chip Quik low temperature alloy uniformly on all pins of SMD. Maintain alloy in molten state long enough for complete reflow.
	3	Lift chip from board with dental pick or vacuum pen.
	4	Thoroughly clean site with swab dipped in flux while applying heat. Clean thoroughly with alcohol pad.

**SMD Removal**

**(With solder iron or warm air bath)**

- Apply flux to all leads.
- Melt CHIP QUIK® uniformly on all pins.
- Maintain alloy in molten state long enough to release chip.
- Lift chip from board with dental pick or vacuum pen.

**CLEAN UP**

- While molten, use cotton swab and flux to move excess to an unused section of board.
- While applying heat, polish each pad with a swab and flux until thoroughly clean.
- At room temperature, clean residue with alcohol pad.
- You are now ready to install the new chip.

**6.5” of thick sticks of Chip Quik® material, removes 1,250 to 1,500 SMD pins.**

**Conforms to the following Industry Standards:**

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders):	Yes
RoHS 3 Directive (EU) 2015/863:	No